LM193, LM293, LM393

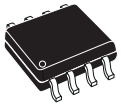
Low power dual voltage comparators

Datasheet – production data

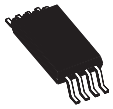
Features

- Wide single-supply voltage range or dual supplies: +2 V to +36 V or ±1 V to ±18 V
- Very low supply current (0.45 mA) independent of supply voltage (1 mW/comparator at +5 V)
- Low input bias current: 20 nA typ.
- Low input offset current: ±3 nA typ.
- Low input offset voltage: ±1 mV typ.
- Input common-mode voltage range includes ground
- Low output saturation voltage: 80 mV typ. (I_{sink} = 4 mA)
- Differential input voltage range equal to the supply voltage
- TTL, DTL, ECL, MOS, CMOS compatible outputs
- Available in DIP8, SO-8, TSSOP8, MiniSO-8, and DFN8 2 x 2 mm packages

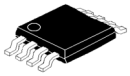
DIP8
(plastic package)



SO-8
(plastic micropackage)



TSSOP8
(thin shrink small outline package)



MiniSO-8
(plastic micropackage)

DFN8 2 x 2 mm
(plastic micropackage)

Description

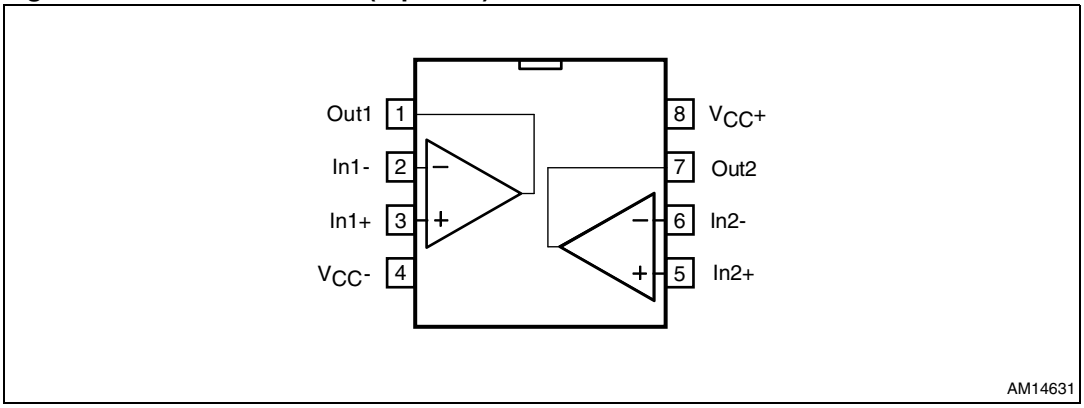
The LM193, LM293, and LM393 devices consist of two independent low voltage comparators designed specifically to operate from a single supply over a wide range of voltages. Operation from split power supplies is also possible.

These comparators also have a unique characteristic in that the input common-mode voltage range includes ground even though operated from a single power supply voltage.

Contents

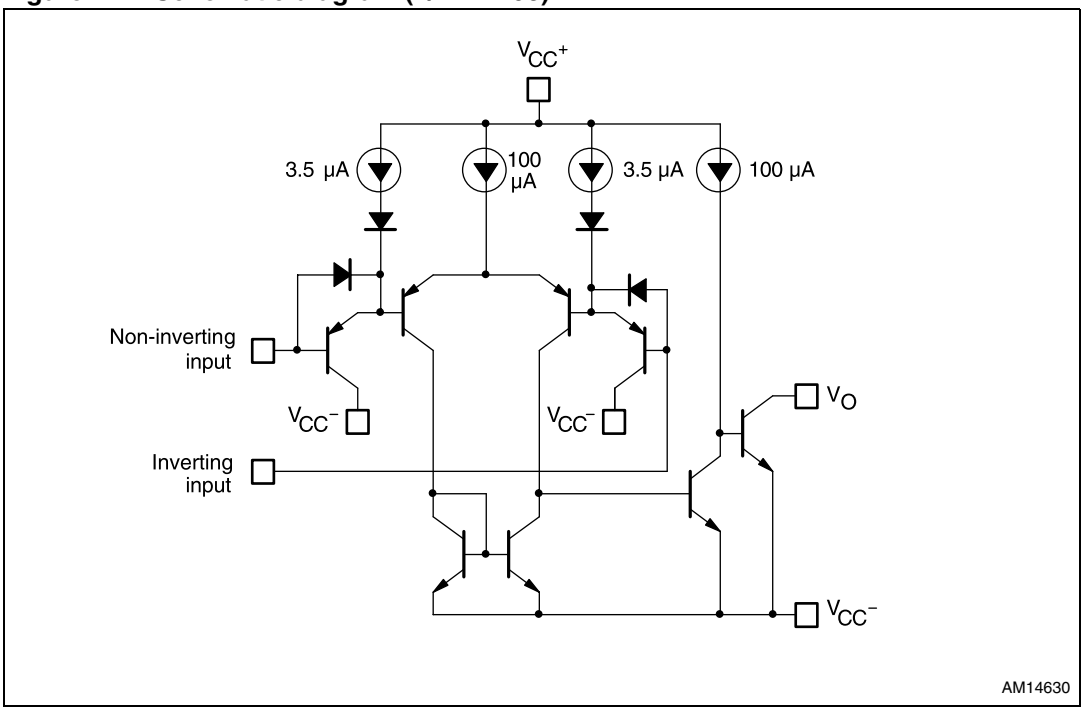
1 Pin connections

Figure 1. Pin connections (top view)



2 Schematic diagram

Figure 2. Schematic diagram (1/2 LM193)



3 Absolute maximum ratings and operating conditions

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	±18 or 36	V
V_{id}	Differential input voltage	±36	V
V_{in}	Input voltage	-0.3 to +36	V
	Output short-circuit to ground(1)	Infinite	
R_{thja}	Thermal resistance junction to ambient(2) SO-8 TSSOP8 DIP8 MiniSO-8 DFN8 2 x 2 mm	 125 120 85 190 57	°C/W
R_{thjc}	Thermal resistance junction to case(2) SO-8 TSSOP8 DIP8 MiniSO-8 DFN8 2 x 2 mm	 40 37 41 39	°C/W
T_j	Maximum junction temperature	150	°C
T_{stg}	Storage temperature range	-65 to +150	°C
ESD Class(3)	HBM: human body model	H1B	
	MM: machine model	M2	
	CDM: charged device model	C5	

1. Short-circuits from the output to V_{CC}+ can cause excessive heating and potential destruction. The maximum output current is approximately 20 mA independent of the magnitude of V_{CC}+.
2. Short-circuits can cause excessive heating and destructive dissipation. Values are typical.
3. ESD class definition from AEC-Q100:
HBM class H1B: ESD voltage level from 500 V to 1000 V
MM class M2: ESD voltage level from 100 V to 200 V
CDM class C5: ESD voltage level greater than 1500 V.

Table 2. Operating conditions

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage (V_{CC}^+ - V_{CC}^-)	2 to 36	V
V_{icm}	Common mode input voltage range (V_{CC}^+= 30 V)(1) T_{amb} = +25 °C $T_{min} \leq T_{amb} \leq T_{max}$	 0 to V_{CC}^+ -1.5 0 to V_{CC}^+ -2	V
T_{oper}	Operating free-air temperature range LM193, LM193A LM293, LM293A LM393, LM393A	 -55 to +125 -40 to +105 0 to +70	°C

1. The input common-mode voltage of either input signal voltage should not be allowed to go negative by more than 0.3 V. The high end of the common-mode voltage range is V_{CC}^+ -1.5 V, but either or both inputs can go to +30 V without damage.

4 Electrical characteristics

Table 3. V_{CC}^+ = +5V, V_{CC}^-= 0V, T_{amb} = +25 °C (unless otherwise specified)

Symbol	Parameter	LM193A - LM293A LM393A			LM193- LM293 LM393			Unit
		Min.	Typ.	Max.	Min	Typ.	Max.	
V_{io}	Input offset voltage(1) $T_{min} \le T_{amb} \le T_{max}$		1	2 4		1	5 9	mV
I_{io}	Input offset current $T_{min} \le T_{amb} \le T_{max}$		3	25 100		3	50 150	nA
I_{ib}	Input bias current (I^+ or I^-)(2) $T_{min} \le T_{amb} \le T_{max}$		20	100 300		20	250 400	nA
A_{vd}	Large signal voltage gain V_{CC} = 15 V, R_L = 15 kΩ, V_o = 1 V to 11 V	50	200		50	200		V/mV
I_{CC}	Supply current (all comparators) V_{CC} = +5 V, no load V_{CC} = +30 V, no load		 0.45 0.6	 1 2.5		 0.45 0.6	 1 2.5	mA
V_{id}	Differential input voltage(3)			V_{CC}^+			V_{CC}^+	
V_{OL}	Low level output voltage V_{id} = -1 V, I_{sink} = 4 mA $T_{min} \le T_{amb} \le T_{max}$		80	400 700		80	400 700	mV
I_{OH}	High level output current V_{CC} = V_o = 30 V, V_{id} = 1 V $T_{min} \le T_{amb} \le T_{max}$		0.1	 1		0.1	 1	nA µA
I_{sink}	Output sink current V_{id}= 1 V, V_o = 1.5 V	6	18		6	18		mA
t_{re}	Response time (4) R_L= 5.1 kΩ connected to V_{CC}^+		1.3			1.3		µs
t_{rel}	Large signal response time R_L= 5.1 kΩ connected to V_{CC}^+ e_I = TTL,$V_{(ref)}$ = +1.4 V		300			300		ns

1. At output switch point, $V_o \approx$ 1.4 V, R_s = 0 with V_{CC}^+ from 5 V to 30 V, and over the full common-mode range (0 V to V_{CC}^+ -1.5 V).
2. The direction of the input current is out of the IC due to the PNP input stage. This current is essentially constant, independent of the state of the output, so no loading charge exists on the reference of input lines.
3. Positive excursions of input voltage may exceed the power supply level. As long as the other voltage remains within the common-mode range, the comparator will provide a proper output state. The low input voltage state must not be less than -0.3 V (or 0.3 V below the negative power supply, if used).
4. The response time specified is for a 100 mV input step with 5 mV overdrive. For larger overdrive signals 300 ns can be obtained.

Figure 3. Supply current vs. supply voltage

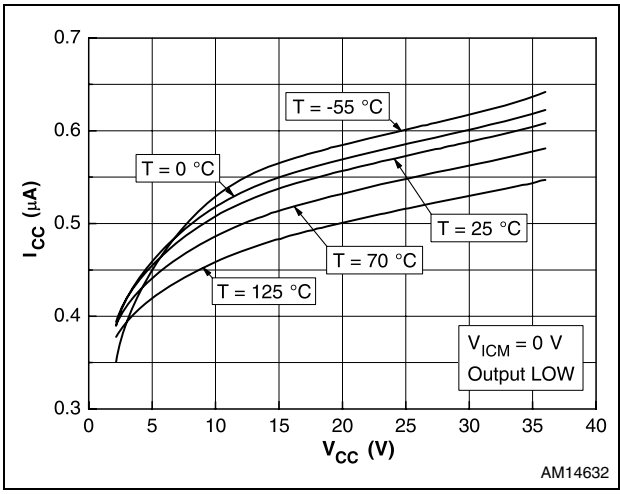


Figure 4. Input current vs. supply voltage

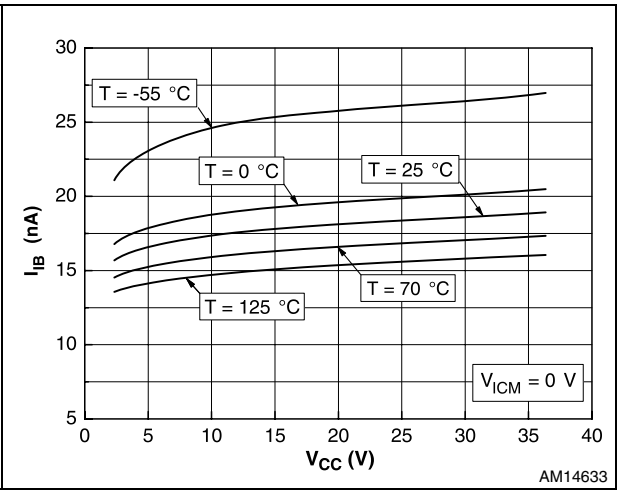


Figure 5. Output saturation voltage vs. output current

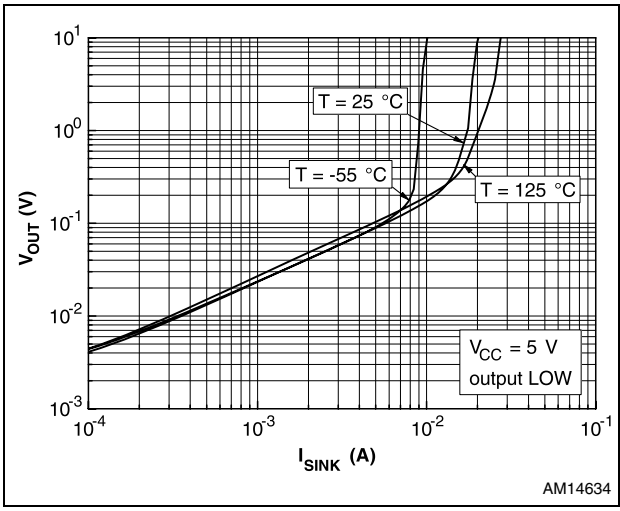


Figure 6. Response time for various input overdrives - negative transition

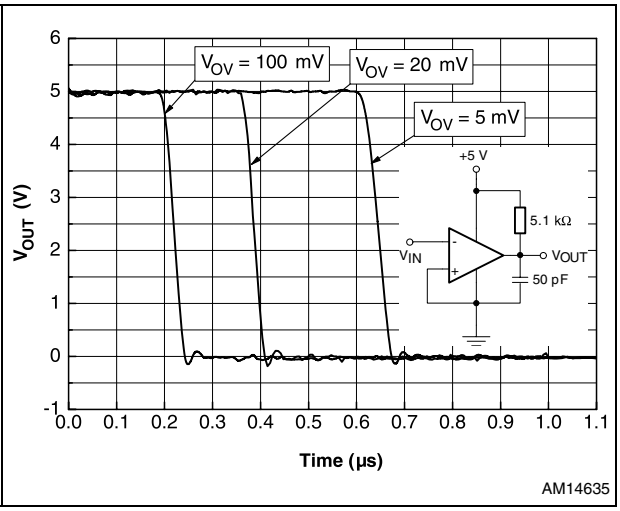
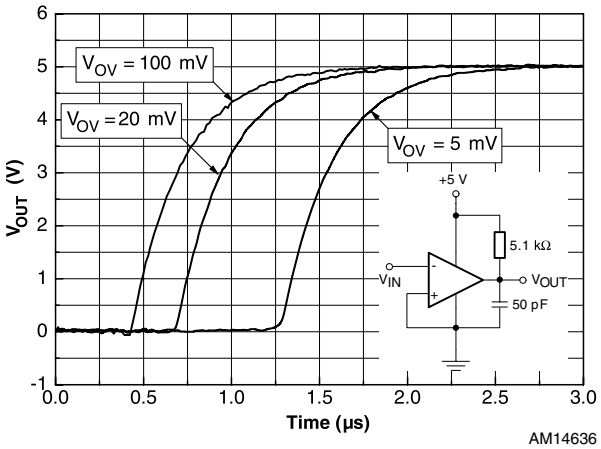


Figure 7. Response time for various input overdrives - positive transition



5 Typical applications

Figure 8. Basic comparator

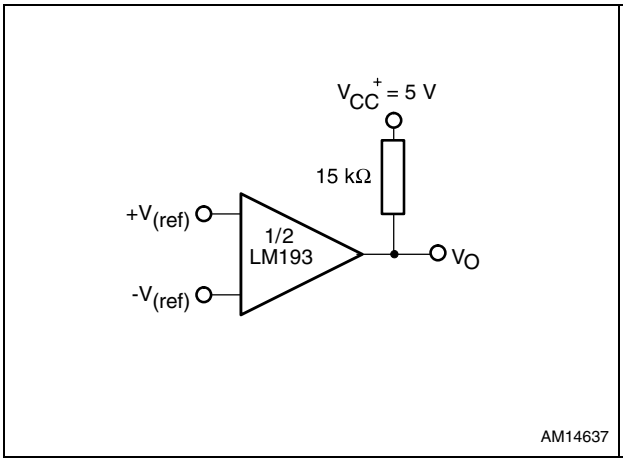


Figure 9. Driving TTL

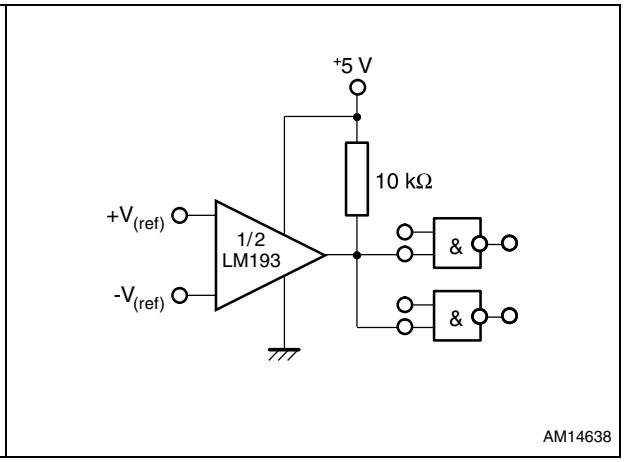


Figure 10. Low frequency op amp

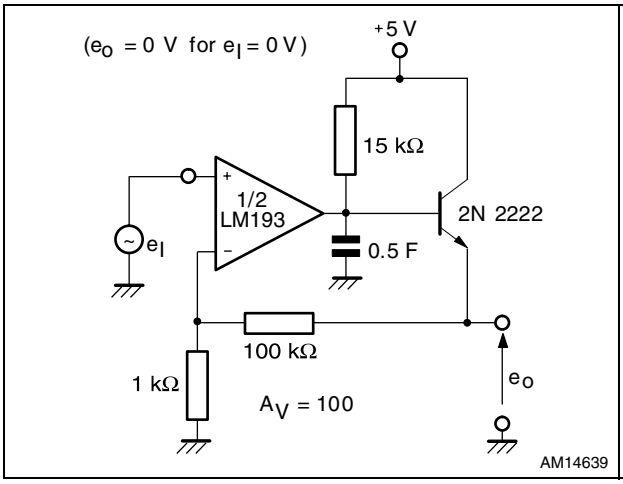


Figure 11. Driving CMOS

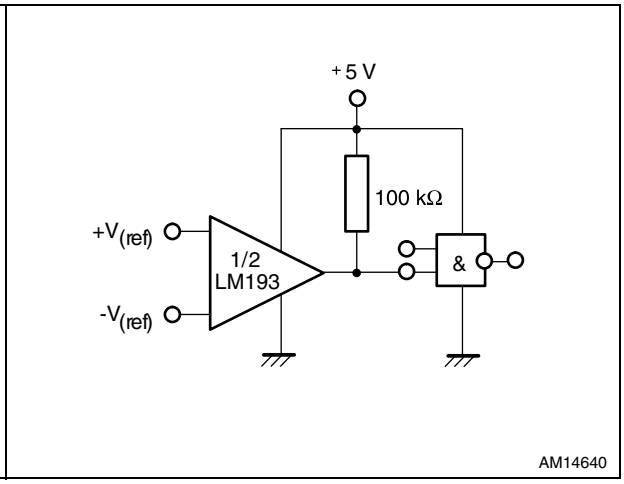


Figure 12. Low frequency op amp

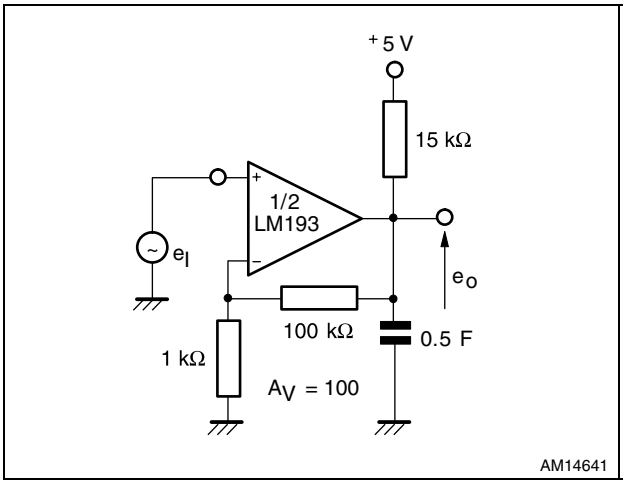


Figure 13. Transducer amplifier

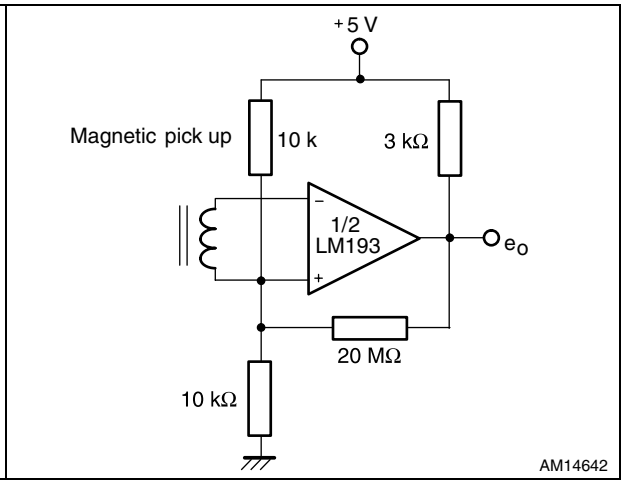


Figure 14. Low frequency op amp with offset adjust

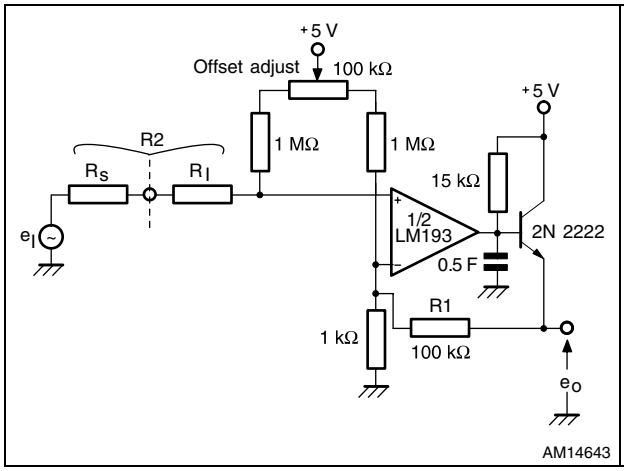


Figure 15. Zero crossing detector (single power supply)

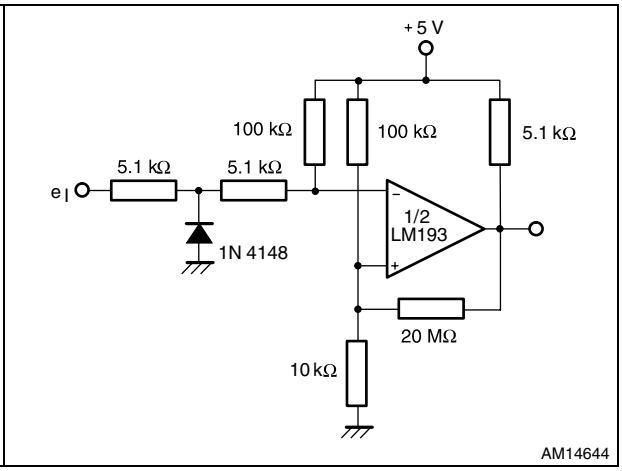


Figure 16. Limit comparator

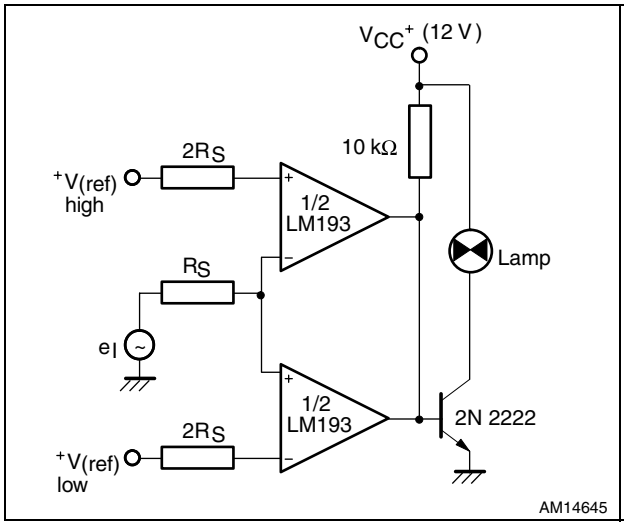


Figure 17. Crystal controlled oscillator

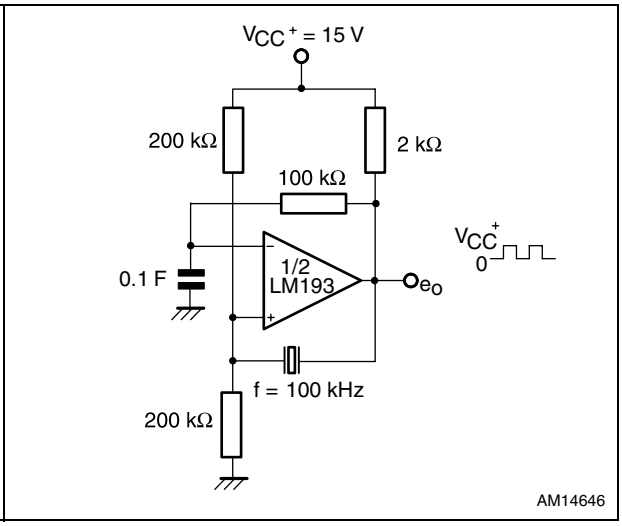


Figure 18. Split-supply applications - zero crossing detector

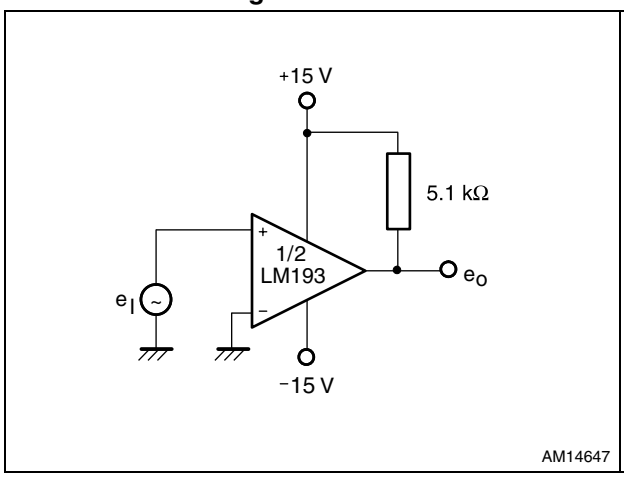


Figure 19. Comparator with a negative reference

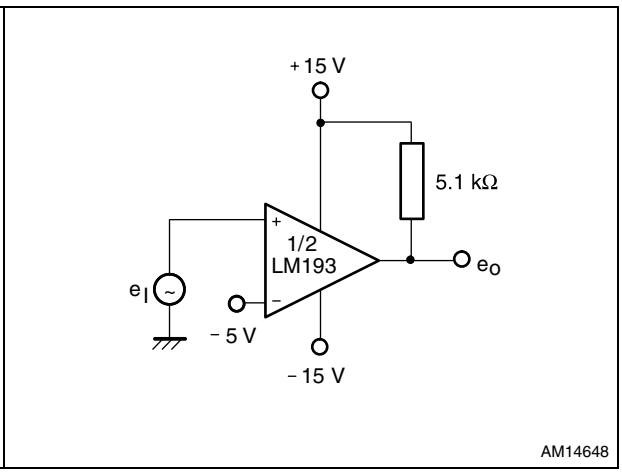
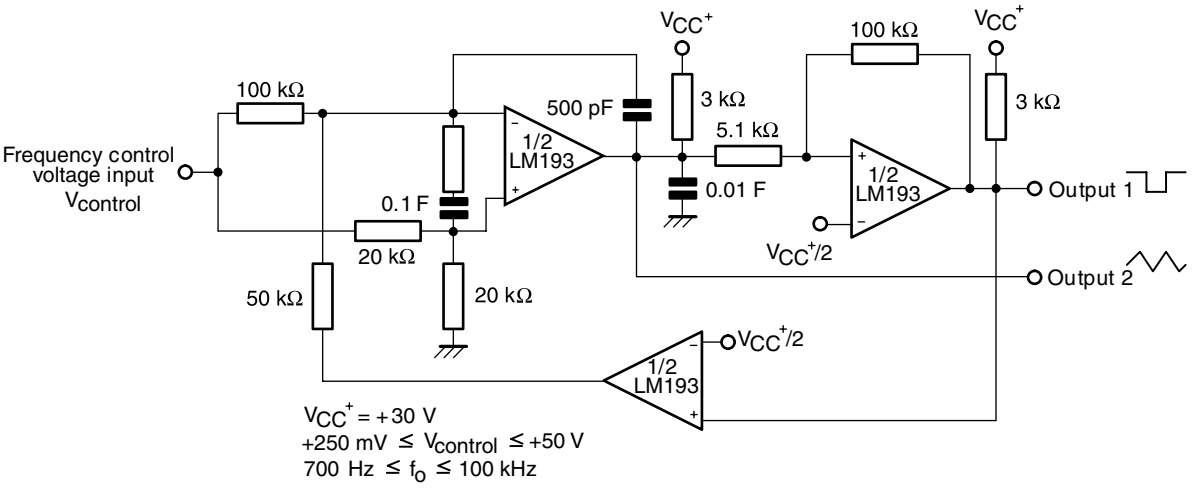


Figure 20. Two-decade high frequency VCO



6 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK is an ST trademark.

6.1 DIP8 package information

Figure 21. DIP8 package outline

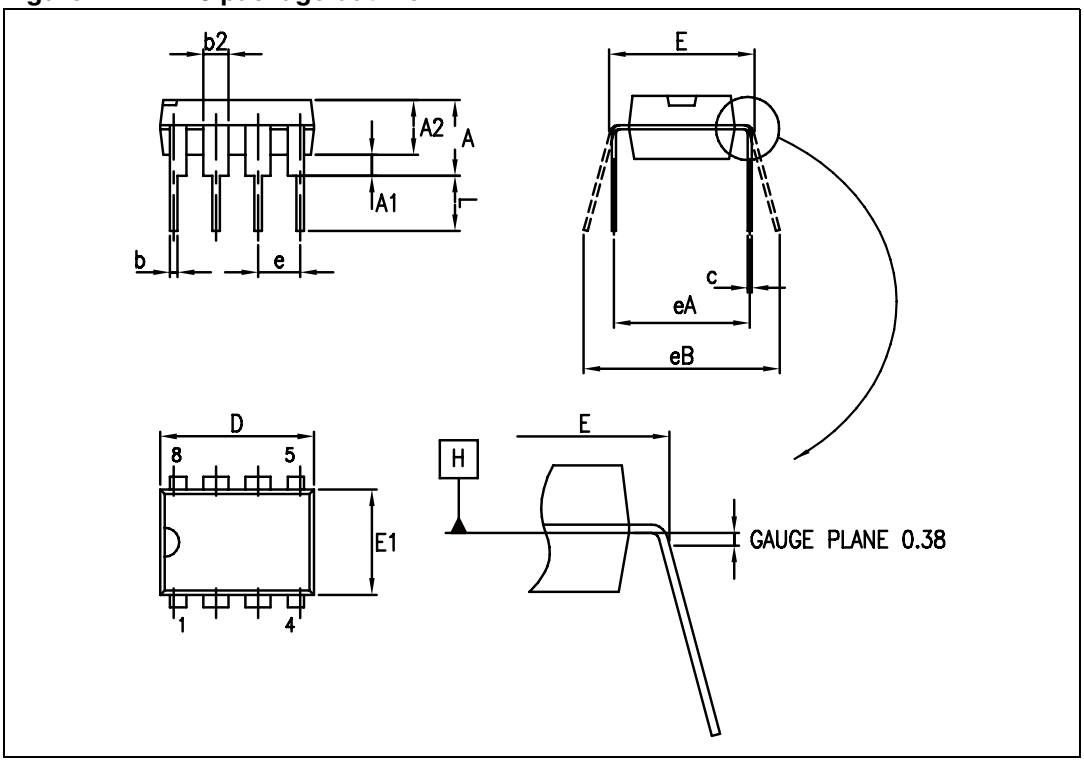


Table 4. DIP8 package mechanical data

Symbol	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			5.33			0.210
A1	0.38			0.015		
A2	2.92	3.30	4.95	0.115	0.130	0.195
b	0.36	0.46	0.56	0.014	0.018	0.022
b2	1.14	1.52	1.78	0.045	0.060	0.070
c	0.20	0.25	0.36	0.008	0.010	0.014
D	9.02	9.27	10.16	0.355	0.365	0.400
E	7.62	7.87	8.26	0.300	0.310	0.325
E1	6.10	6.35	7.11	0.240	0.250	0.280
e		2.54			0.100	
eA		7.62			0.300	
eB			10.92			0.430
L	2.92	3.30	3.81	0.115	0.130	0.150

6.2 SO-8 package information

Figure 22. SO-8 package outline

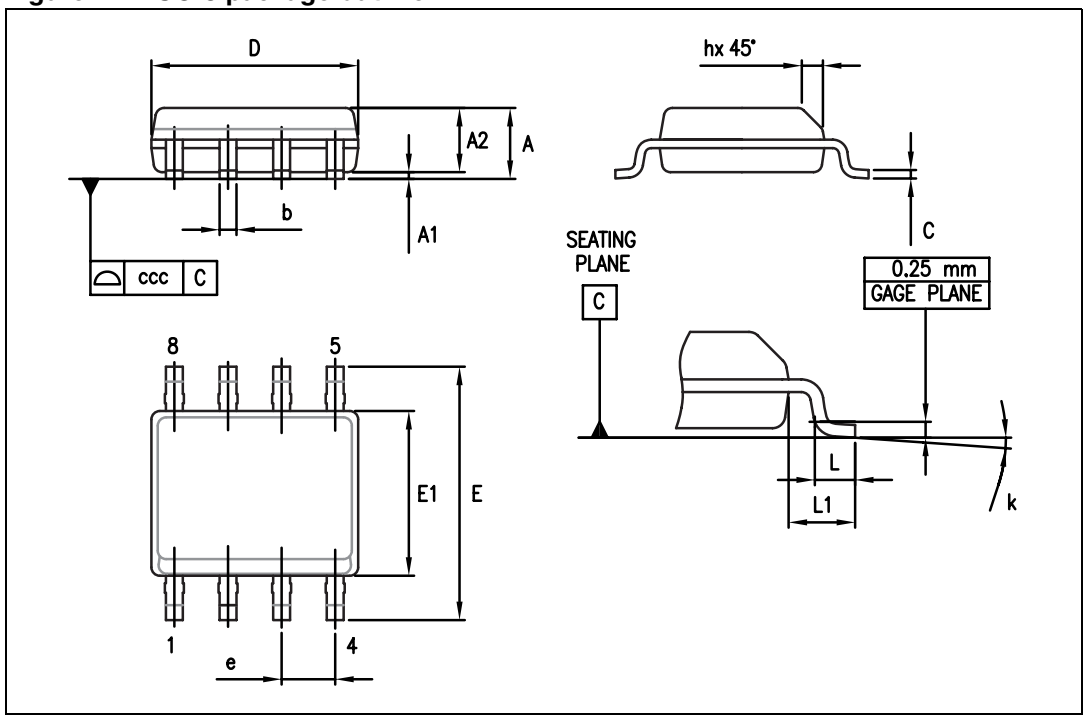


Table 5. SO-8 package mechanical data

Symbol	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.069
A1	0.10		0.25	0.004		0.010
A2	1.25			0.049		
b	0.28		0.48	0.011		0.019
c	0.17		0.23	0.007		0.010
D	4.80	4.90	5.00	0.189	0.193	0.197
E	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
e		1.27			0.050	
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
L1		1.04			0.040	
k	0		8°	1°		8°
ccc			0.10			0.004

6.3 TSSOP8 package information

Figure 23. TSSOP8 package outline

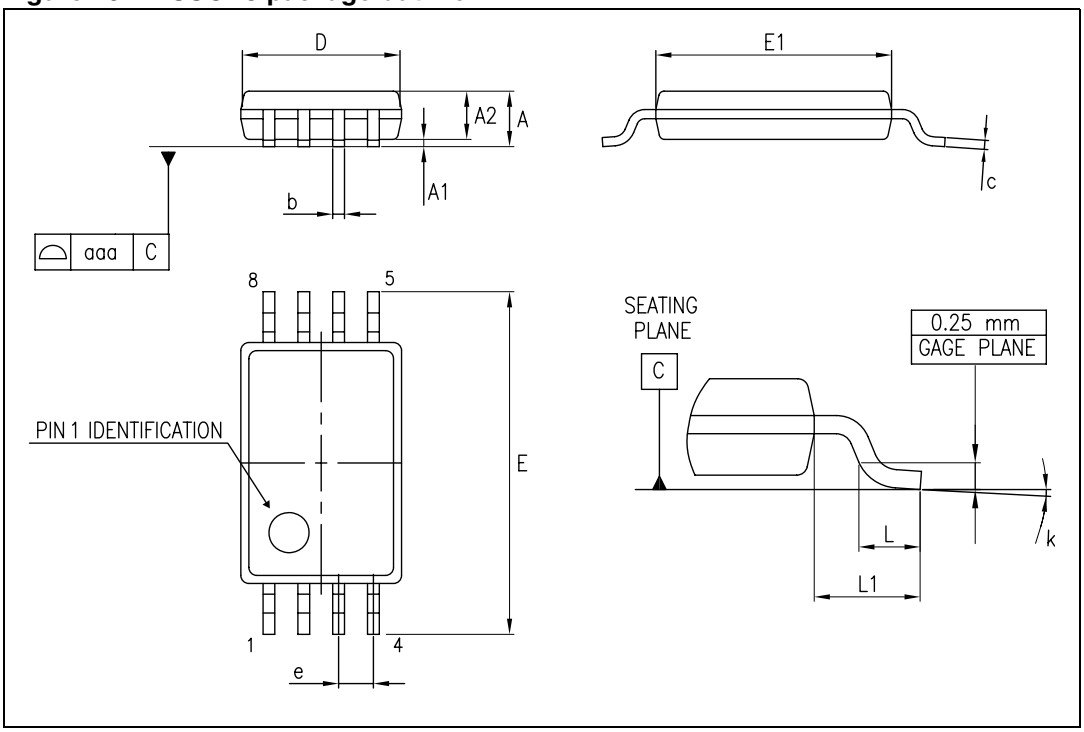


Table 6. TSSOP8 package mechanical data

Symbol	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.20			0.047
A1	0.05		0.15	0.002		0.006
A2	0.80	1.00	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.008
D	2.90	3.00	3.10	0.114	0.118	0.122
E	6.20	6.40	6.60	0.244	0.252	0.260
E1	4.30	4.40	4.50	0.169	0.173	0.177
e		0.65			0.0256	
k	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030
L1		1			0.039	
aaa			0.10			0.004

6.4 MiniSO-8 package information

Figure 24. MiniSO-8 package outline

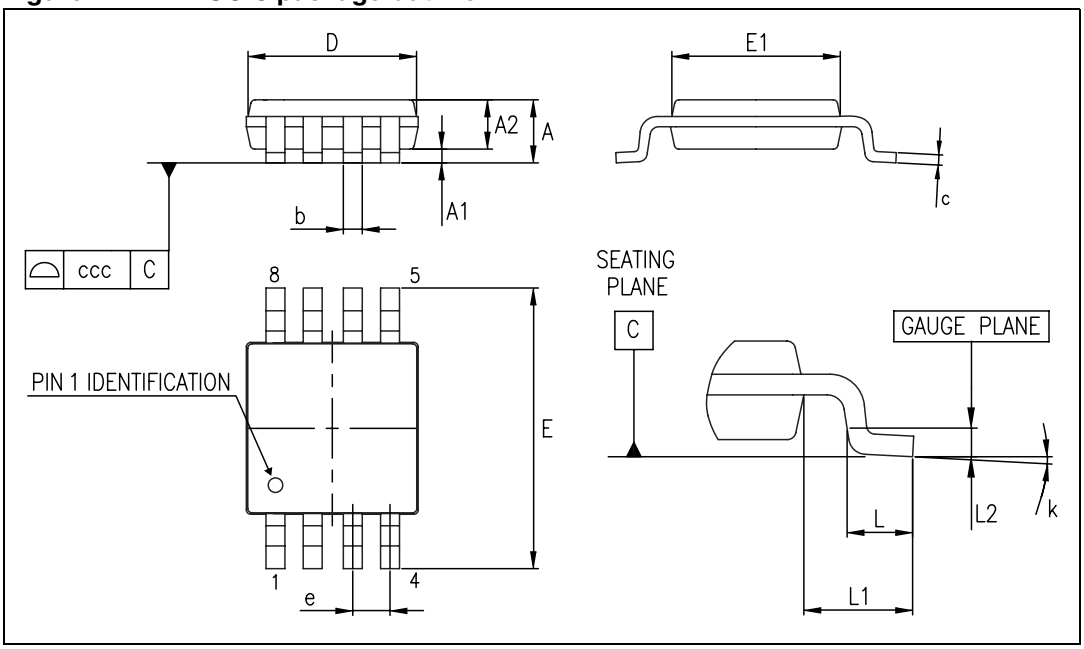


Table 7. MiniSO-8 package mechanical data

Symbol	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.1			0.043
A1	0		0.15	0		0.006
A2	0.75	0.85	0.95	0.030	0.033	0.037
b	0.22		0.40	0.009		0.016
c	0.08		0.23	0.003		0.009
D	2.80	3.00	3.20	0.11	0.118	0.126
E	4.65	4.90	5.15	0.183	0.193	0.203
E1	2.80	3.00	3.10	0.11	0.118	0.122
e		0.65			0.026	
L	0.40	0.60	0.80	0.016	0.024	0.031
L1		0.95			0.037	
L2		0.25			0.010	
k	0°		8°	0°		8°
ccc			0.10			0.004

6.5 DFN8 package information

Figure 25. DFN8 2 x 2 x 0.6 mm package outline (pitch 0.5 mm)

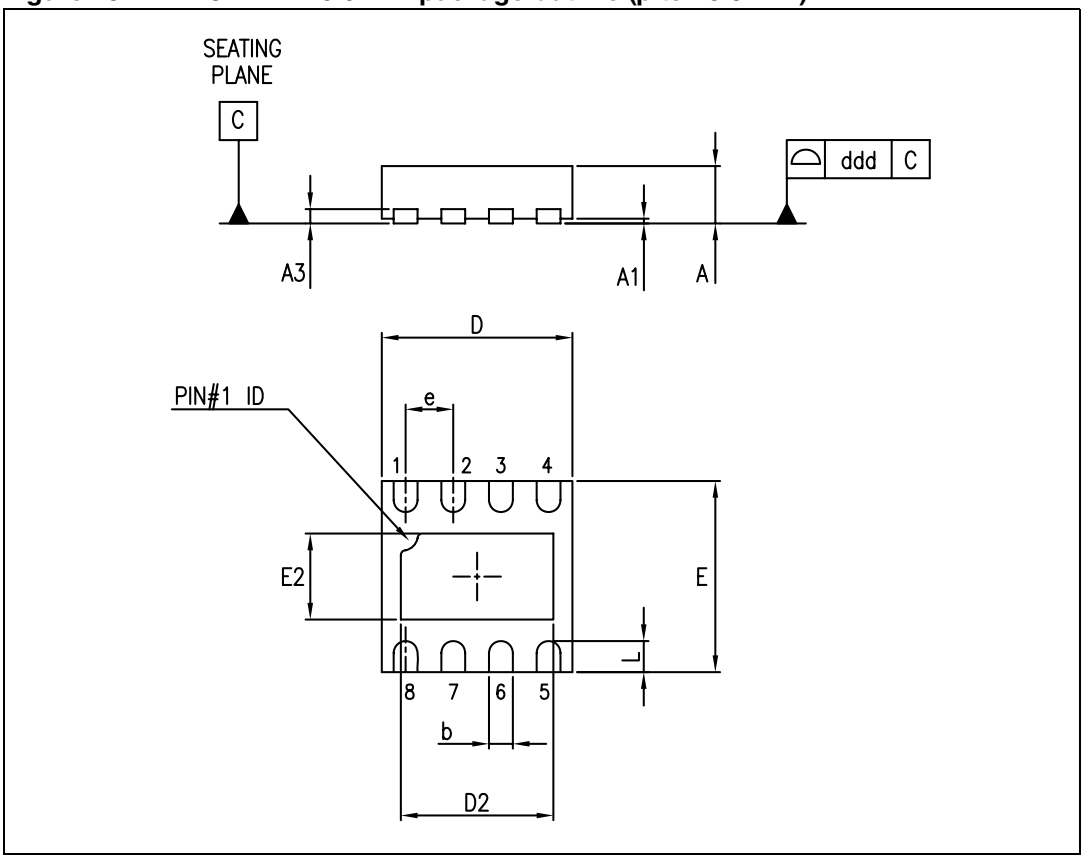
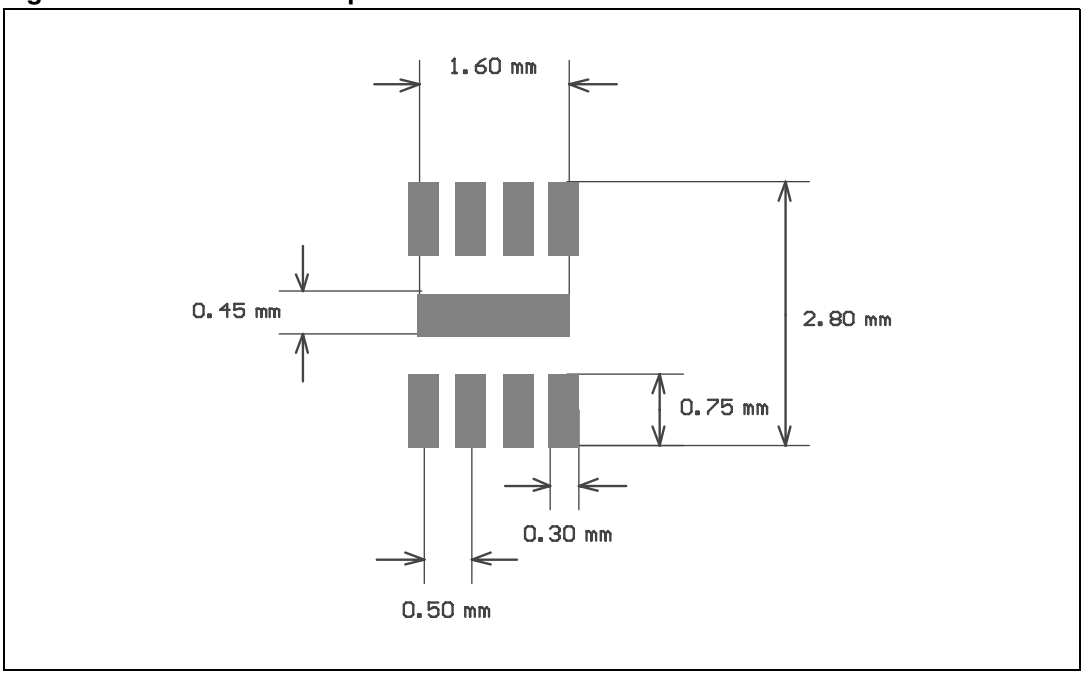


Table 8. DFN8 2 x 2 x 0.6 mm package mechanical data (pitch 0.5 mm)

Symbol	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.51	0.55	0.60	0.020	0.022	0.024
A1			0.05			0.002
A3		0.15			0.006	
b	0.18	0.25	0.30	0.007	0.010	0.012
D	1.85	2.00	2.15	0.073	0.079	0.085
D2	1.45	1.60	1.70	0.057	0.063	0.067
E	1.85	2.00	2.15	0.073	0.079	0.085
E2	0.75	0.90	1.00	0.030	0.035	0.039
e		0.50			0.020	
L			0.50			0.020
ddd			0.08			0.003

Figure 26. DFN8 2 x 2 footprint recommendation



7 Ordering information

Table 9. Order codes

Order code	Temperature range	Package	Packing	Marking
LM193AD LM193ADT	-55 °C, +125 °C	SO-8	Tube or tape and reel	193A
LM193D LM193DT				193
LM193AN		DIP8	Tube	LM193AN
LM193N				LM193N
LM293AD LM293ADT	-40 °C, +105 °C	SO-8	Tube or tape and reel	293A
LM293D LM293DT				293
LM293AN		DIP8	Tube	LM293AN
LM293N				LM293N
LM293PT		TSSOP8	Tape and reel	293
LM293ST		MiniSO-8	Tape and reel	K512
LM293QT		DFN8 2 x 2	Tape and reel	K59
LM393AD LM393ADT	0 °C, +70 °C	SO-8	Tube or tape and reel	393A
LM393D LM393DT				393
LM393AN		DIP8	Tube	LM393AN
LM393N				LM393N
LM393PT		TSSOP8	Tape and reel	393
LM393ST		MiniSO-8	Tape and reel	M393
LM393QT		DFN8 2 x 2	Tape and reel	K5C

8 Revision history

Table 10. Document revision history

Date	Revision	Changes
02-Jul-2002	1	First release.
02-Jan-2005	2	Class A of the product included in the datasheet.
02-May-2005	3	PPAP references inserted in the datasheet, see *Table 7: Ordering information on page 18*.
02-Jul-2005	4	Modification on PPAP references - Errors on part numbers, see *Table 7: Ordering information on page 18*.
22-Nov-2005	5	Modification on *Table 3 on page 6*. LM293,A must be -40/+105°C instead of -40/+125°C.
16-Feb-2006	6	Unit error for V_{ol} parameter see *Table 3 on page 6*.
23-Aug-2007	7	Corrected error in DIP8 package information related to lead thickness, see *Figure 21 on page 12*. Added values for R_{thja} and R_{thjc}, and ESD parameters in *Table 1: Absolute maximum ratings*.
08-Nov-2007	8	Updated MiniSO-8 package information. Reformatted package information. Added automotive grade order codes.
19-Feb-2008	9	Corrected error in SO-8 package mechanical data: E dimension in drawing was marked with an F in table.
15-Dec-2008	10	Corrected heading in *Figure 5*.
22-Feb-2010	11	Deleted automotive grade order codes for LM293 and LM393.
22-Jun-2011	12	Updated typical performance curves. Updated typical values on*Table 3 on page 6*. Updated ESD parameters with ESD classes in *Table 1: Absolute maximum ratings*. Added DFN8 2x2mm package mechanical drawing. Added DFN8 2x2mm recommended footprint. Added DFN8 2x2mm order codes in *Table 9*.
27-Jun-2012	13	Updated *Features* (added package information), *Description* (added RPNs), *Figure 1: Pin connections (top view)* moved to page 3, added *Contents*, updated marking of the LM293QT device in *Table 9*, minor text corrections throughout document.
18-Jan-2013	14	Updated *Table 8* (added dimensions in inches).

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